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	CPC1030N	Units
Blocking Voltage	350	V _P
Load Current	120	mA
Max R _{on}	30	Ω

Features

- Small 4 Pin SOP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- · Arc-Free With No Snubbing Circuits
- 1500V_{rms} Input/Output Isolation
- No EMI/RFI Generation
- · Machine Insertable, Wave Solderable
- Tape & Reel Version Available

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hookswitch
 - · Dial Pulsing
 - Ground Start
 - Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - · Electronic Switching
 - I/O Subsystems
 - · Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The CPC1030N is a miniature 1-Form-A solid state relay in a 4 pin SOP package that employs optically coupled MOSFET technology to provide 1500V_{rms} of input to output isolation. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS® architecture. The optically coupled input is controlled by a highly efficient GaAIAs infrared LED. The CPC1030N uses Clare's state of the art double molded vertical construction packaging to produce the world's smallest relay. The CPC1030N offers board space savings of at least 20% over the competitor's larger 4 pin SOP relay.

Approvals

 UL Recognized Component File#: E76270

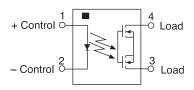
Certified to: EN60950

Ordering Information

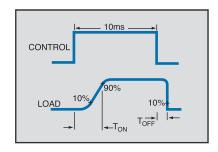
Part #	Description
CPC1030N	4 Pin SOP (100/tube)
CPC1030NTR	4 Pin SOP (2000/reel) picked from pin 1 side
CPC1030NTR-1	4 Pin SOP (100/tube) picked from pin 3 side

Pin Configuration

CPC1030N Pinout



Switching Characteristics of Normally Open (Form A) Devices





Absolute Maximum Ratings (@ 25° C)

Parameter	Ratings	Units	
Blocking Voltage	350	V_P	
Reverse Input Voltage	5	V	
Input Control Current	50	mA	
Peak (10ms)	1	А	
Input Power Dissipation	150	mW	
Total Power Dissipation	400 ¹	mW	
Isolation voltage Input to Output	1500	V_{rms}	
Operational Temperature	-40 to +85	°C	
Storage Temperature	-40 to +125	°C	
Soldering Temperature (10 seconds Max.)	+220	°C	

¹ Derate Linearly 3.33 mw / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

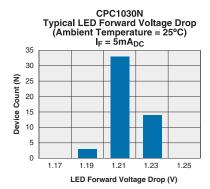
Electrical Characteristcs

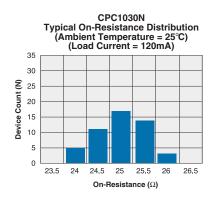
Parameter	Conditions	Symbol	Min	Тур	Max	Units		
Output Characteristics @ 25°C								
Load Current AC Peak ¹	Continuous	IL	-	-	120	mA		
Peak Load Current	10ms	I _{LPK}	-	-	350	mA		
On-Resistance ²	I _L =120mA	R _{ON}	-	25	30	Ω		
Off-State Leakage Current	V _L =350V	I _{LEAK}	-	-	1	μA		
Switching Speeds Turn-On	I _F =5mA, V _L =10V	T _{ON}	-	-	2	ms		
Turn-Off	I _F =5mA, V _L =10V	T _{OFF}	-	-	1.0	ms		
Output Capacitance	50V; f=1MHz	C _{OUT}	-	25	_	pF		
Input Characteristics @ 25°C								
Input Control Current ³	I _L =120mA	I _E	2	-	-	mA		
Input Dropout Current	-	I _F	0.3	0.9	-	mA		
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V		
Reverse Input Current	V _R =5V	I _B	-	-	10	μA		
Input/Output Characteristics @ 25°C	<u>.</u>							
Capacitance Input to Output	-	-	-	1	-	pF		
					_			

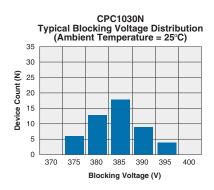
Load current derates linearly from 120mA @ 25°C to 80mA @85°C.
Measurement taken within 1 second of on time.
For applications requiring high temperature operation (greater than 60°C) an LED drive current of 10mA is recommended.

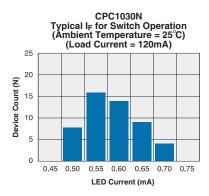


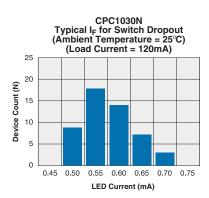
PERFORMANCE DATA*

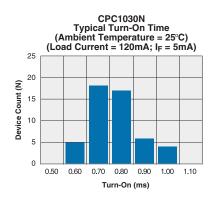


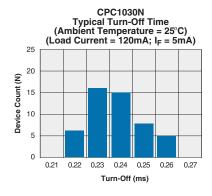


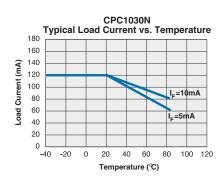


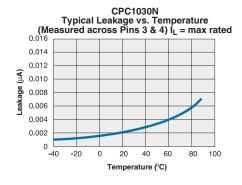


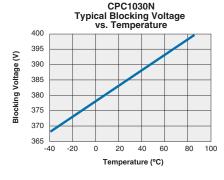


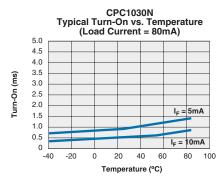


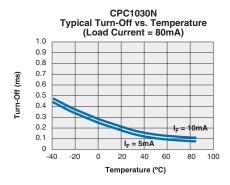








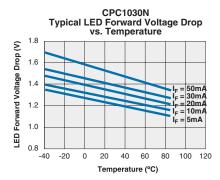


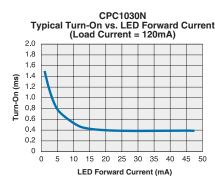


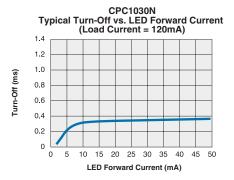
^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

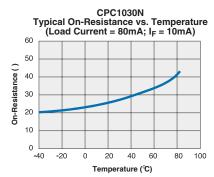


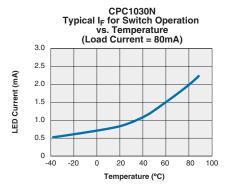
PERFORMANCE DATA*

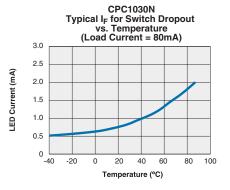


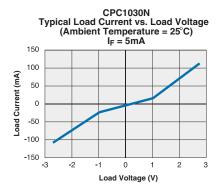


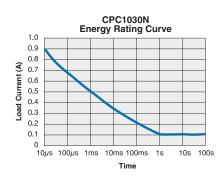








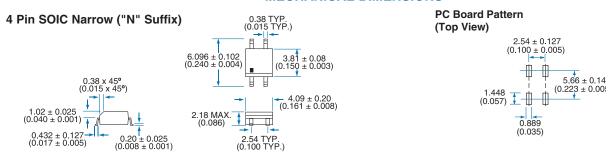




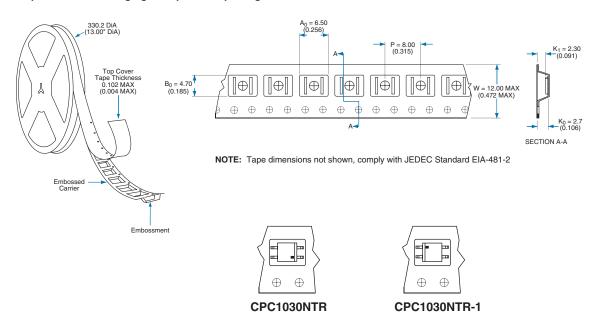
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MECHANICAL DIMENSIONS



Tape and Reel Packaging for 4 pin SOIC package



Dimensions: mm (inches)

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